









Release Date: 03 April 2019 Version: A1.2

PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 1204SV 2.0t Series
- ► Red (630nm) / Green (570nm)

NOD48S47SV





1204SV 2.0t Series

APPLICATIONS:

- Indicator
- Dashboard
- 3C Application
- Backlighting
- **Decoration Lighting**

1204SV 2.0t Series Compliant





FEATURES (Red/Green):

Package: PCB / CHIP Side View LED

Forward Current: 20/20mA*

Forward Voltage (typ.): 2.0/2.0V

Luminous Intensity (typ.): 80/70mcd@20mA

Colour: Red/Green

Wavelength: 630/570nm

Viewing angle: 150/150°

Materials:

Die: AlGaInP/GaAs *2

Resin: Epoxy (Water Clear)

Operating Temperature: -40~+80°C

Storage Temperature: -40~+85°C

ESD (HBM): 2000V

Grouping parameters:

Forward voltage

Luminous intensity

Dominant Wavelength

Soldering methods: Reflow soldering

Preconditioning: acc. to JEDEC Level 3

Packing:: 8mm tape with max.3000/reel, ø180mm (7")

* In the order of Red/Green.



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	l _F	30/30*	mA
Peak Forward Current Duty 1/8@1KHz	I _{FP}	125	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	IR	10	μΑ
Power Dissipation	P _D	75/75	mW
Electrostatic Discharger (HBM)	ESD	2000/2000	V
Operating Temperature	T _{OPR}	-40~+80	°C
Storage Temperature	T _{STG}	-40~+85	°C

^{1. *} In the order of Red/Green.

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V_{F}	1.7/1.7*	2.0/2.0	2.5/2.5	V	I _F =20mA
Luminous Intensity	lv	50/40	80/70	160/125	mcd	I _F =20mA
Dominant Wavelength	λ_{D}	625/565	630/570	635/576	nm	I _F =20mA
Peak Wavelength	$\lambda_{ extsf{P}}$		640/570		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		18/16		nm	I _F =20mA
Viewing Angle	2θ _{1/2}		150		deg	I _F =20mA

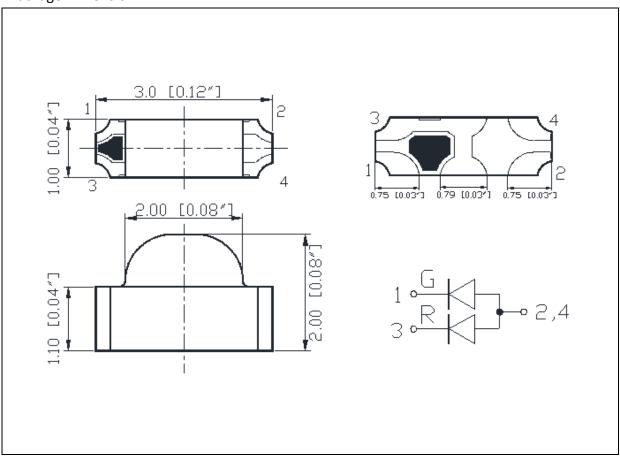
^{1. *} In the order of Red/Green.

^{2.} Luminous intensity (I_V) ±15%, Forward Voltage (V_F) ±0.1V



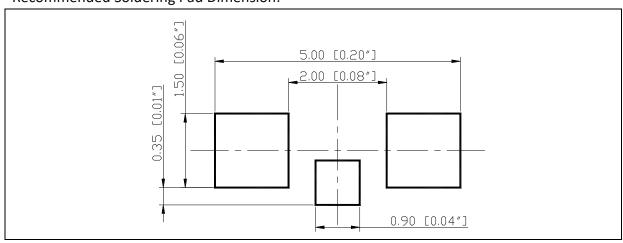
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

	Code	Min.	Max.	Unit
Red		1.7	2.5	V
Green		1.7	2.5	V

Luminous Intensity Classifications (IF = 20mA):

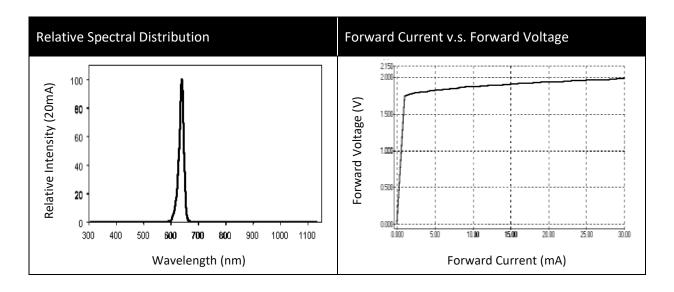
	Code	Min.	Max.	Unit
	G	50	63	
	Н	63	80	
Red	I	80	100	mcd
	J	100	125	
	К	125	160	
	F	40	50	
	G	50	63	
Green	Н	63	80	mcd
	I	80	100	
	J	100	125	

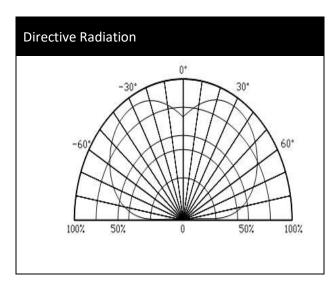
Wavelength Classifications (I_F = 20mA):

	Code	Min.	Max.	Unit	
Red	U	625	630	nm	
	V	630	635	nm	
Green	Н	565	568		
	1	568	572	nm	
	J	572	576		



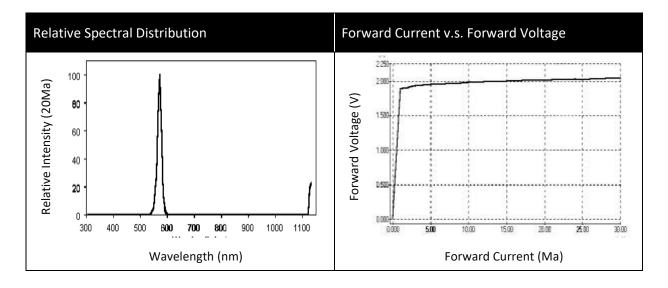
ELECTRO-OPTICAL CHARACTERISTICS (RED):

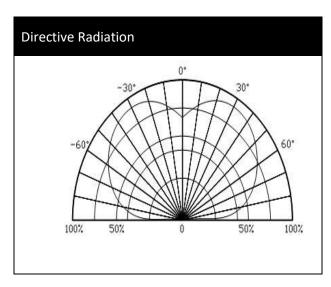






ELECTRO-OPTICAL CHARACTERISTICS (GREEN):

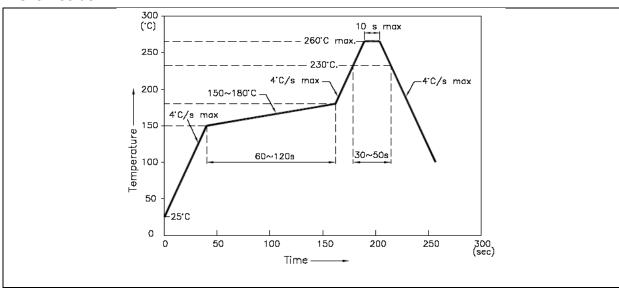






RECOMMENDED SOLDERING PROFILE:

Reflow Solder:



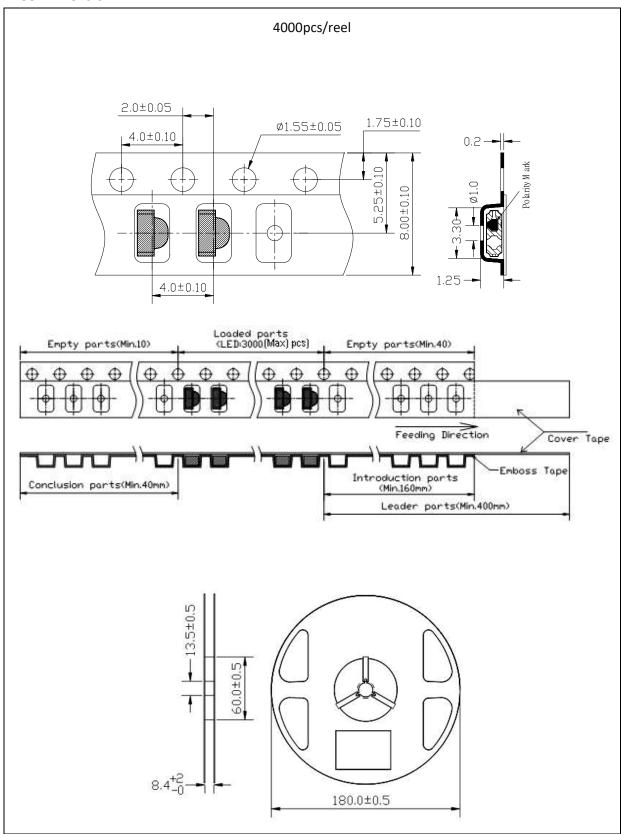
Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking.

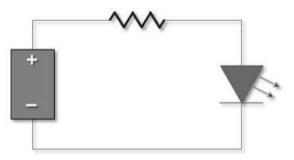
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light Blue) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	26/03/2019	Datasheet set-up.
A1.1	27/03/2019	Correct description (p.6).
A1.2	03/04/2019	Add ESD values.